

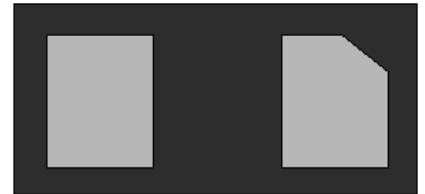


FEATURES

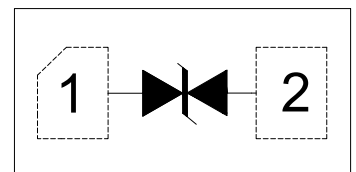
- ✧ Solid-state silicon technology
- ✧ Low clamping voltage
- ✧ Ultra-low leakage current
- ✧ Ultra low capacitance
- ✧ RoHS compliant

MAIN APPLICATIONS

- ✧ USB 2.0& USB 3.0
- ✧ HDMI 1.3.HDMI 1.4 and HDMI 2.0
- ✧ SATA and eSATA interface
- ✧ DVI
- ✧ IEEE 1394
- ✧ Portable electronics and notebooks



DFN0603-2L(Bottom view)



Pin Configuration(Top view)

PROTECTION SOLUTION TO MEET

- ✧ IEC61000-4-2 (ESD) $\pm 30\text{kV}$ (air), $\pm 30\text{kV}$ (contact)
- ✧ IEC61000-4-4 (EFT) 40A (5/50ns)
- ✧ IEC61000-4-5 (Lightning) 5.5A (8/20 μs)

MECHANICAL CHARACTERISTICS

- ✧ DFN0603-2L package
- ✧ Molding compound flammability rating: UL 94V-0
- ✧ Quantity per reel: 10,000pcs
- ✧ Lead finish: lead free
- ✧ Marking code: Q

ABSOLUTE MAXIMUM RATINGS ($T_A=25^{\circ}\text{C}$, RH=45%-75%, unless otherwise noted)

Parameter	Symbol	Value	Unit
Peak pulse power dissipation at 8/20 μs waveform	P_{PP}	55	W
ESD per IEC 61000-4-2 (Air) ESD per IEC 61000-4-2 (Contact)	V_{ESD}	+/-30 +/-30	kV
Lead soldering temperature	T_L	260 (10 sec.)	$^{\circ}\text{C}$
Operating junction temperature range	T_J	-55 to +125	$^{\circ}\text{C}$
Storage temperature range	T_{STG}	-55 to +150	$^{\circ}\text{C}$

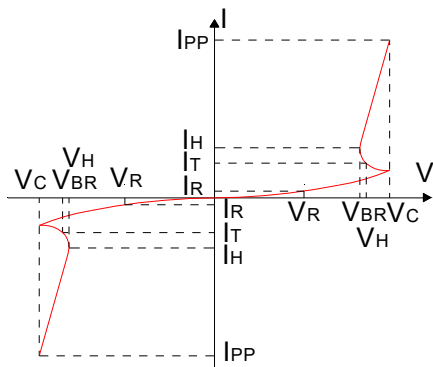
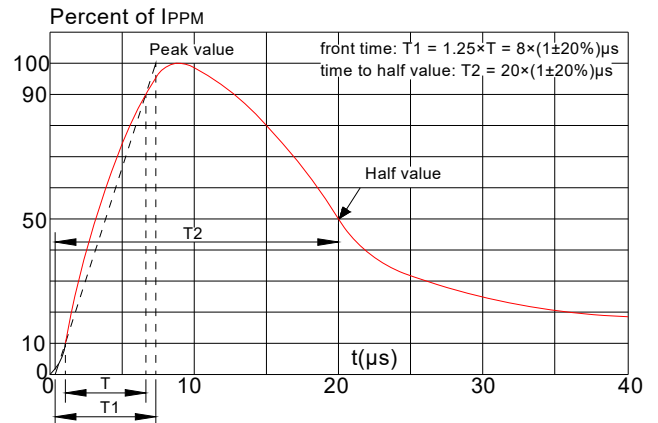
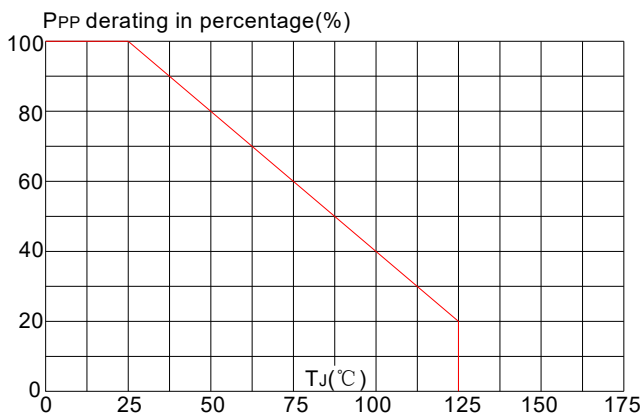
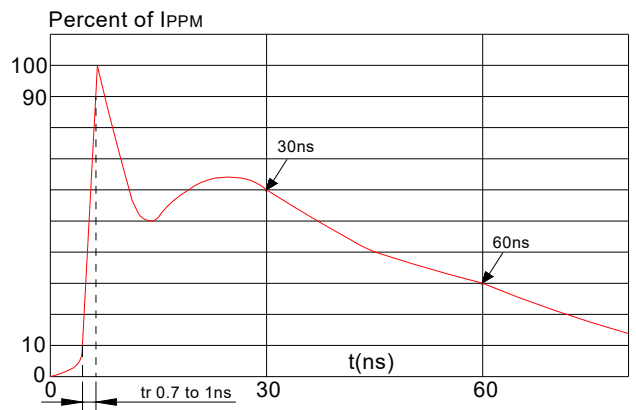
ELECTRICAL CHARACTERISTICS ($T_A=25^{\circ}\text{C}$)

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Reverse working voltage	V_{RWM}				5.0	V
Reverse breakdown voltage	V_{BR}	$I_T=1\text{mA}$	5.8		9.5	V
Reverse leakage current	I_R	$V_{RWM}=5\text{V}$			0.2	μA
Holding voltage	V_H	$I_H=80\text{mA}$	5.2			V
Clamping voltage ^①	V_C	$I_{PP}=16\text{A}$, $t_P=100\text{ns}$		9		V
Dynamic resistance ^①	R_{DYN}			0.22		Ω
Clamping voltage ^②	V_C	$V_{ESD}=8\text{kV}$		9		V
Clamping voltage ^③	V_C	$I_{PP}=1\text{A}$, $t_P=8/20\mu\text{s}$		5.8	7.5	V
		$I_{PP}=5.5\text{A}$, $t_P=8/20\mu\text{s}$		8	10	V
Junction capacitance	C_J	$V_{RWM}=0\text{V}$, $f=1\text{MHz}$		0.3	0.4	pF

Note:

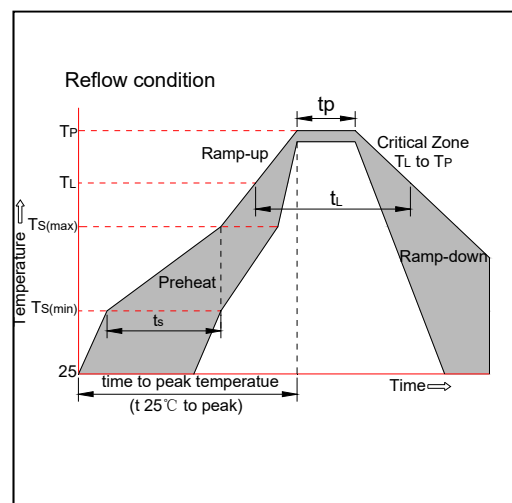
- ① Clamping voltage was measured by transmission Line Pulse Test (TLP), TLP conditions: $Z_0=50\Omega$, $t_r=0.6\text{ns}$, $t_P=100\text{ns}$, I_{TLP} and V_{TLP} averaging window from 70ns to 90ns. R_{DYN} is calculated from 4A to 16A.
- ② Contact discharge mode, according to IEC61000-4-2.
- ③ Clamping voltage was measured by 8/20 μs current waveform, $R_S=2\Omega$, according to IEC61000-4-5.

RATINGS AND V-I CHARACTERISTICS CURVES ($T_A=25^\circ\text{C}$, unless otherwise noted)

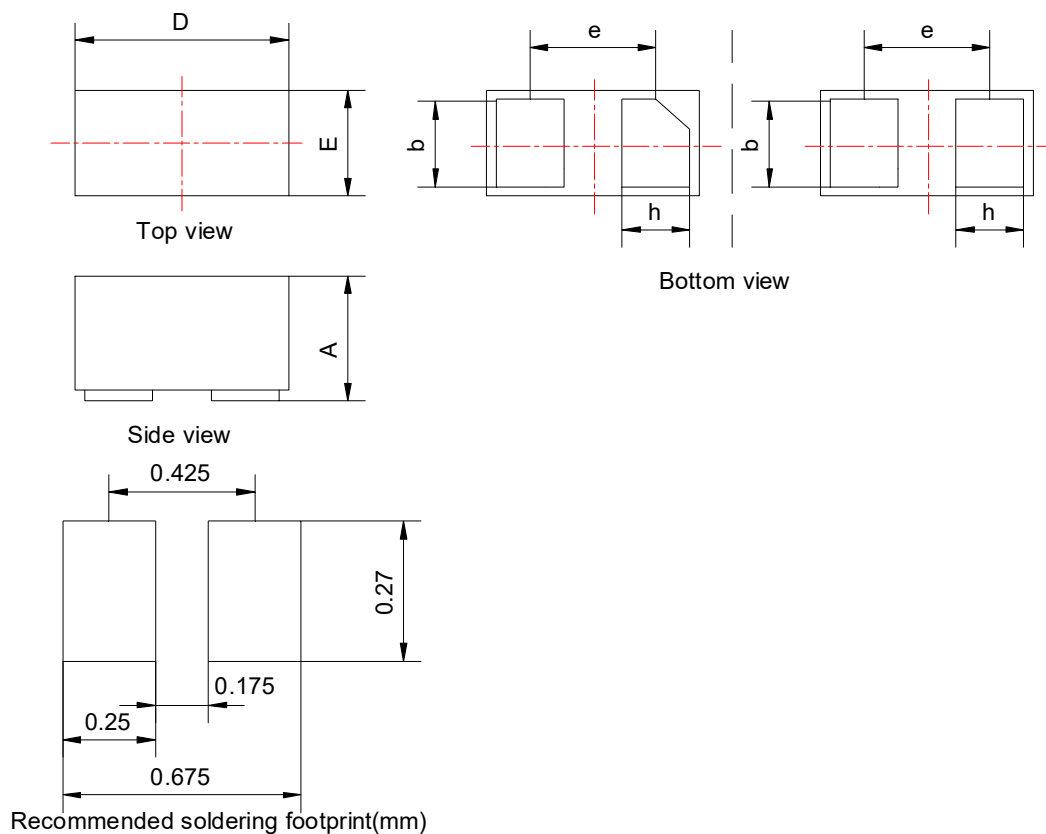
FIG.1: V- I curve characteristics (Bi-directional)

FIG.2: Pulse waveform (8/20 μs)

FIG.3: Pulse derating curve

FIG.4: ESD clamping (30kV contact)


SOLDERING PARAMETERS

Reflow Condition		Pb-Free assembly (see figure at right)
Pre Heat	-Temperature Min ($T_{s(min)}$)	+150°C
	-Temperature Max($T_{s(max)}$)	+200°C
	-Time (Min to Max) (t_s)	60-180 secs.
Average ramp up rate (Liquidus Temp (T_L) to peak)		3°C/sec. Max
$T_{s(max)}$ to T_L - Ramp-up Rate		3°C/sec. Max
Reflow	-Temperature(T_L)(Liquidus)	+217°C
	-Temperature(t_L)	60-150 secs.
Peak Temp (T_P)		+260(+0/-5)°C
Time within 5°C of actual Peak Temp (t_p)		20-40secs.
Ramp-down Rate		6°C/sec. Max
Time 25°C to Peak Temp (T_P)		8 min. Max
Do not exceed		+260°C

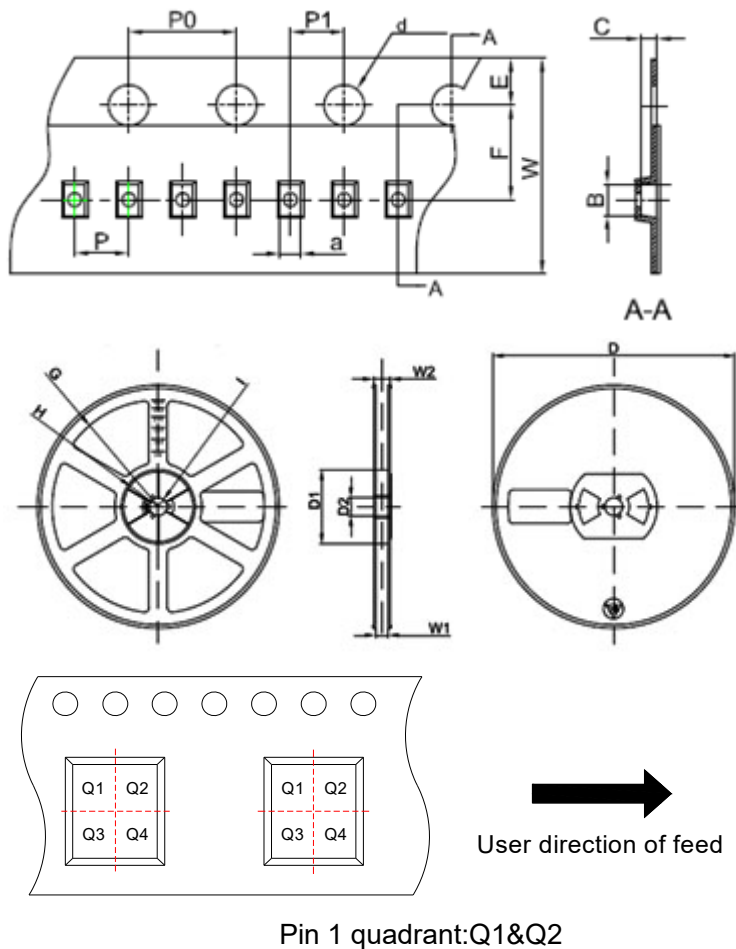


PACKAGE MECHANICAL DATA



Symbol	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	0.25	0.30	0.34	0.010	0.012	0.013
D	0.55	0.60	0.65	0.022	0.024	0.026
E	0.25	0.30	0.35	0.010	0.012	0.014
b	0.2	0.23	0.3	0.008	0.009	0.012
e	0.4			0.016		
h	0.13	0.17	0.24	0.005	0.007	0.009

TAPE AND REEL INFORMATION-DFN0603-2L



Packaging Description:

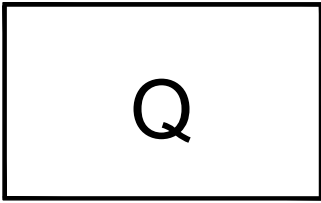
DFN0603-2L parts are shipped in tape. The carrier tape is made from a dissipative(carbon filled) polycarbonate resin. The cover tape is a multilayer film(heat activated adhesive in nature)primarily composed of polyester film, adhesive layer, sealant, and anti-static sprayed agent. These reeled parts in standard option are shipped with 10,000units per 7" or 17.8cm diameter reel. The reels are clear in color and made of polystyrene plastic(anti-static coated).

Symbol	Millimeters	Inches
	Typ.	Typ.
a	0.41	0.016
B	0.70	0.028
C	0.38	0.015
d	Φ1.50	Φ0.059
E	1.75	0.069
F	3.50	0.138
P0	4.00	0.157
P	2.00	0.079
P1	2.00	0.079
W	8.00	0.315
D	Φ178	Φ7.008
D1	54.40	2.142
D2	13.00	0.512
G	R78.00	R3.071
H	R25.60	R1.008
I	R6.50	R0.256
W1	9.50	0.374
W2	12.30	0.484

ORDERING INFORMATION

PART No.	PACKAGE TYPE	QUANTITY(PCS) REEL	DESCRIPTION
JEB05VCDS-A1	DFN0603-2L	10,000	7 inch reel pack

MARKING CODE

Part Number	Marking Code
JEB05VCDS-A1	

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